

DK500-HXXX-IMX8P

Preliminary



Website: aglaisense.com

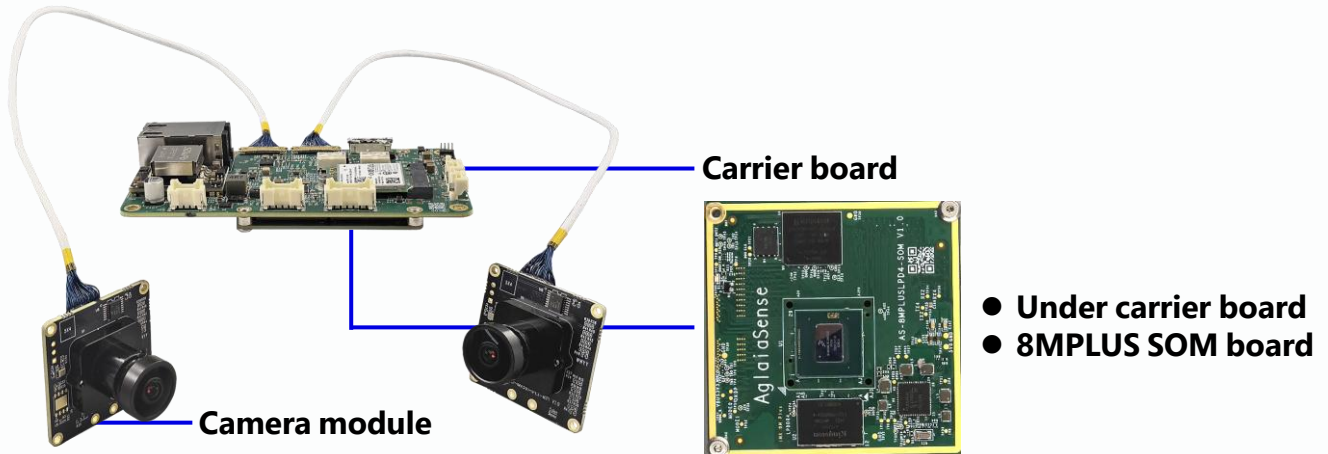
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The **DK500-HXXX-IMX8P** integrates a Sony 4K AI sensor to enable edge-based data analysis and real-time processing. Designed for low power consumption, scalability, and rapid deployment, it facilitates the upgrade of legacy urban infrastructure for smart city transformation. Its edge AI capabilities support diverse applications, including traffic control, road management, pedestrian safety, and other smart city infrastructure.



Features

- **4K Imaging and Analytics** Delivers high-definition clarity to improve accuracy in object detection, recognition, and complex visual data processing.
- **Embedded Edge AI** Enhances real-time processing speeds while reducing latency and bandwidth requirements. Localized processing improves data privacy, security, and connection stability.
- **Low power consumption** Minimizes operational costs and reduces environmental impact through optimized power efficiency.
- **Deployment and Scalability** Features a modular design for rapid deployment, high scalability, and broad system compatibility.

Application

- **Smart city/building** Traffic/parking management, dynamic lighting, etc.
- **Smart logistic**
- **Industrial automation**

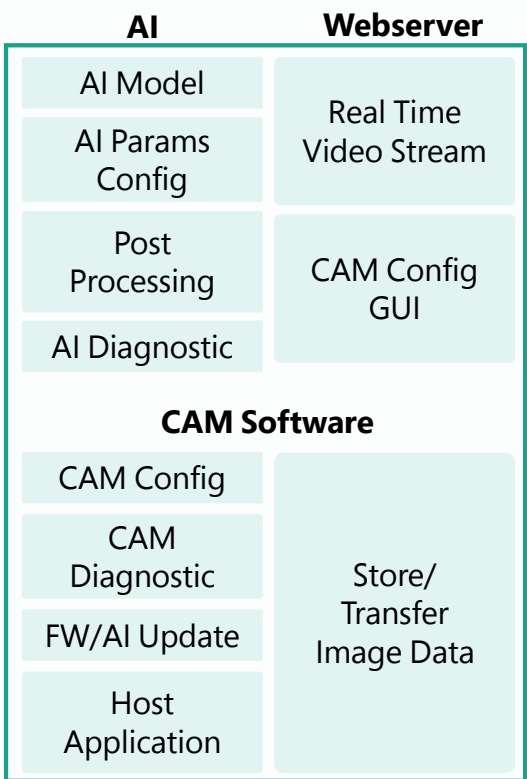
Specifications

Sensor	Sony Diagonal 7.857 mm 12.3MP CMOS Intelligent Vision Sensor IMX501 with AI Processing Functionality
Optical Format	1/2.3"
Pixel Size	1.55 x 1.55 μm
QTY of Camera Modules	2
Platform	i.MX 8M Plus
Camera Resolution & Frame Rate	RAW image: 2 * 2016 x 1520 @ 30fps (Binning mode)
ISP + AI Processing	Supported
WIFI	Supported
Ethernet Connection	Supported
AI Function	Traffic counting, speed calculation, regional alarm, asset protection, object detection, parking...
Lens FOV (H)	42° / 90° / 120°
Region Of Interest (ROI)	Configurable
Color / Mono	Color sensor
Power Supply Range	12 ~ 24 + 4 VDC, or POE
Average Power Consumption	~ 6.5W
Operating Temp	-20°C ~ +65°C
Storage Temp	-20°C ~ +80°C
Dimension	CB board: 112 (L) x 58.5 (W) mm Sensor board: 38 (L) x 38 (W) mm
Weight	~ 125g

Part Number

Part Number	Description
DK500-H120-IMX8P	Dual camera, FOVH 120° lens
DK500-H090-IMX8P	Dual camera, FOVH 90° lens
DK500-H042-IMX8P	Dual camera, FOVH 42° lens

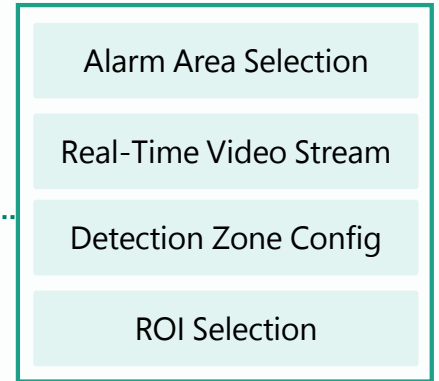
DK500 IMX8P Sensing System



Mobile Devices

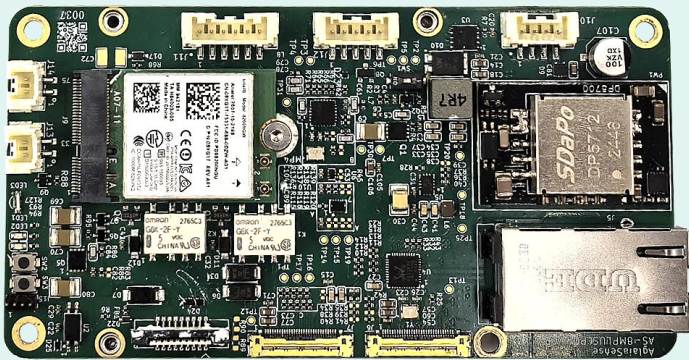


WIFI

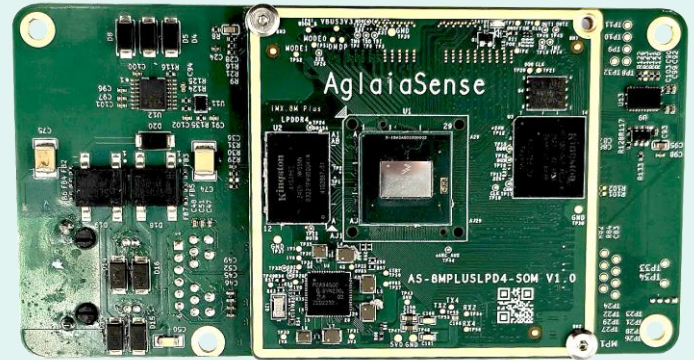


Ethernet





Main Interfaces on CB

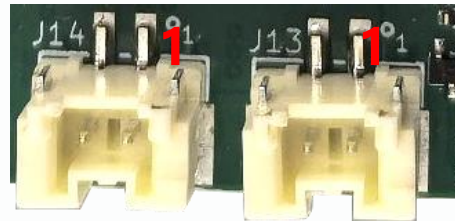


CB + SOM Board

Interface

Pin Definition

Interface J13 & J14 (Lens Heater, Optional, N/A)



Interface J5 (Gigabit Ethernet)



Interface for SD Card

Not used by default



Interface J6 and J7 (To CAM)

Part#: 20525-030E-02
 Number of positions: 30
 Number of rows: 1
 Pitch: 0.4 mm

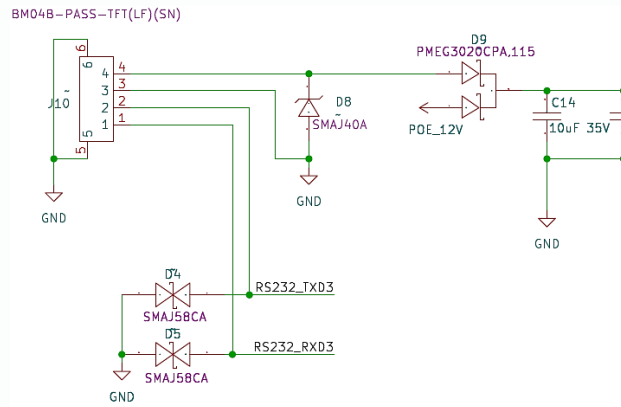
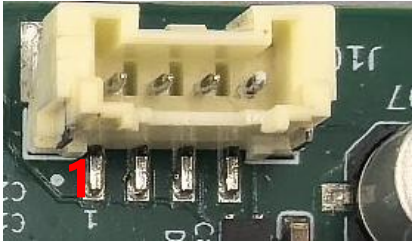


Interface

Pin Definition

Interface J10 (Power)

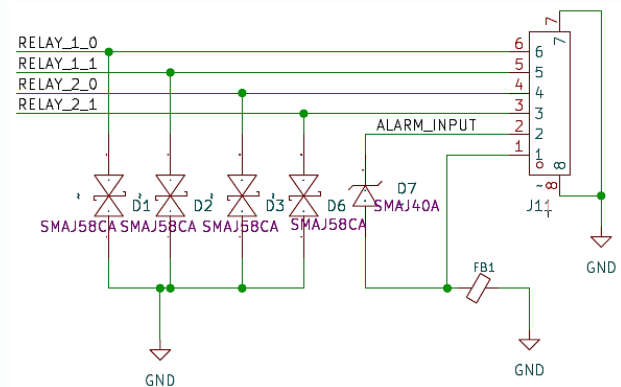
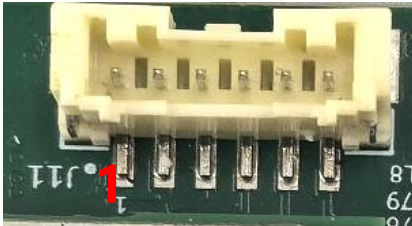
Part#: BM04B-PASS-TFT(LF)(SN)
 Number of positions: 4
 Number of rows: 1
 Pitch: 2 mm



No.	Definition
1	RS232_RXD3
2	RS232_TXD3
3	GND
4	12 ~ 24V DC

Interface J11 (Alarm)

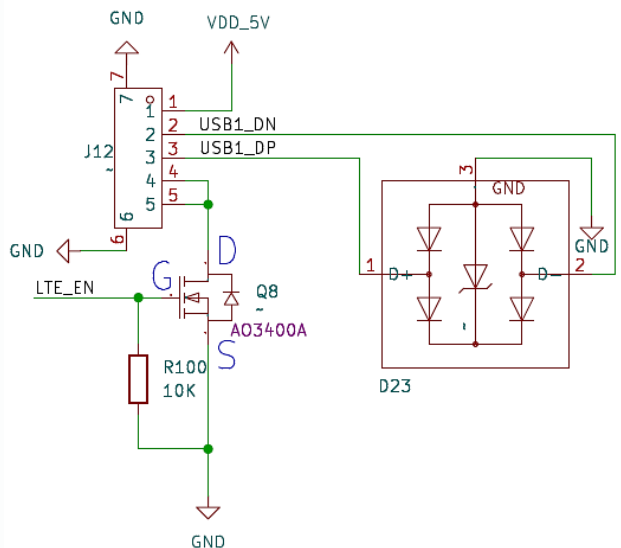
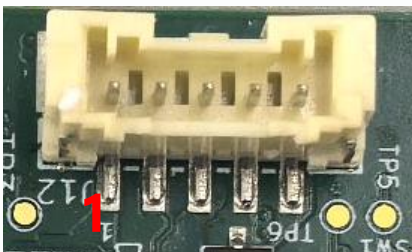
Part#: BM06B-PASS-TFT(LF)(SN)
 Number of positions: 6
 Number of rows: 1
 Pitch: 2 mm



No.	Definition
1	GND
2	ALARM_INPUT
3	RELAY_2_1
4	RELAY_2_0
5	RELAY_1_1
6	RELAY_1_0

Interface J12 (To USB LTE or Other USB Devices)

Part#: BM05B-PASS-TFT(LF)(SN)
 Number of positions: 5
 Number of rows: 1
 Pitch: 2 mm



No.	Definition
1	VDD_5V
2	USB1_DN
3	USB1_DP
4/5	GND, controlled by MOS

Reach out to us if you have questions

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